

FOO22T" 6T52200F

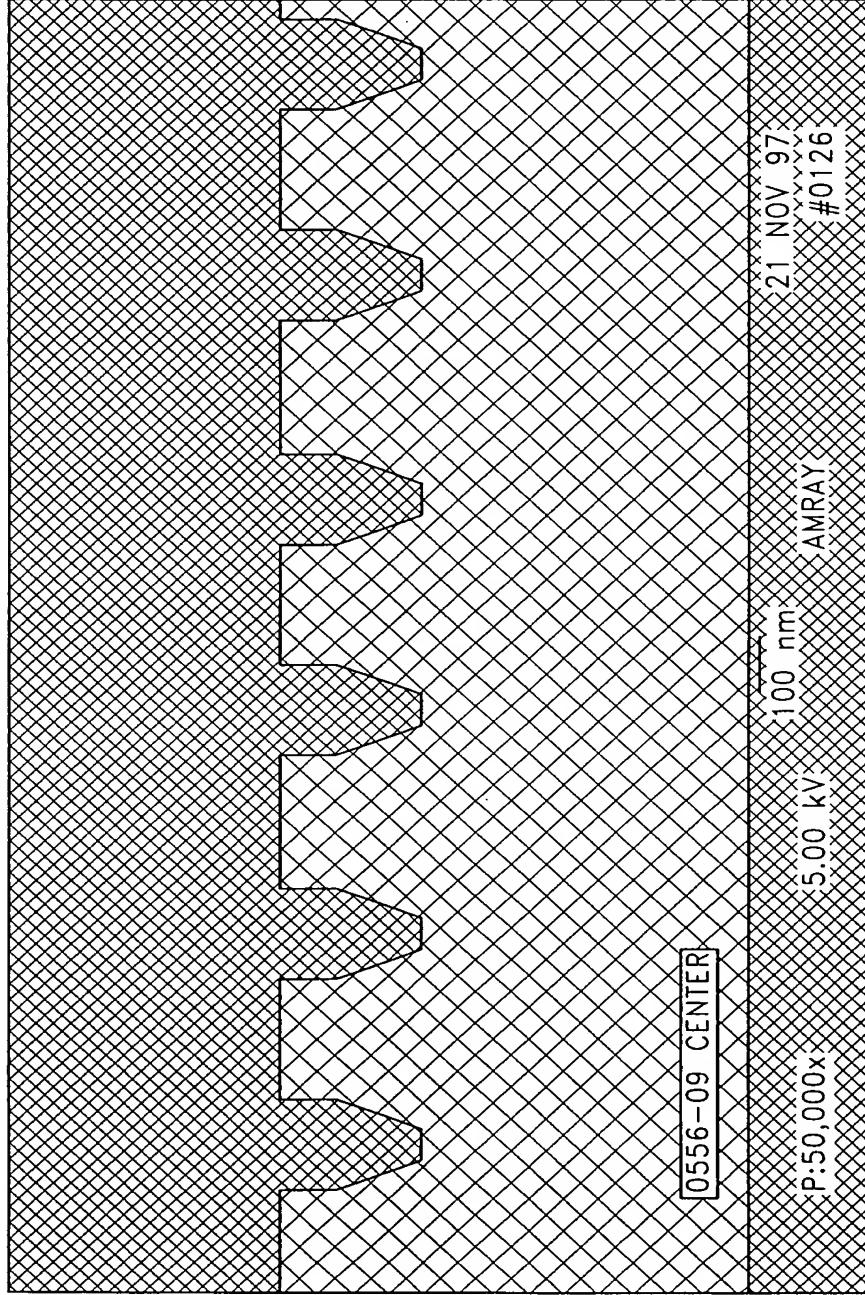


FIG. 1
(PRIOR ART)

10027519-122001

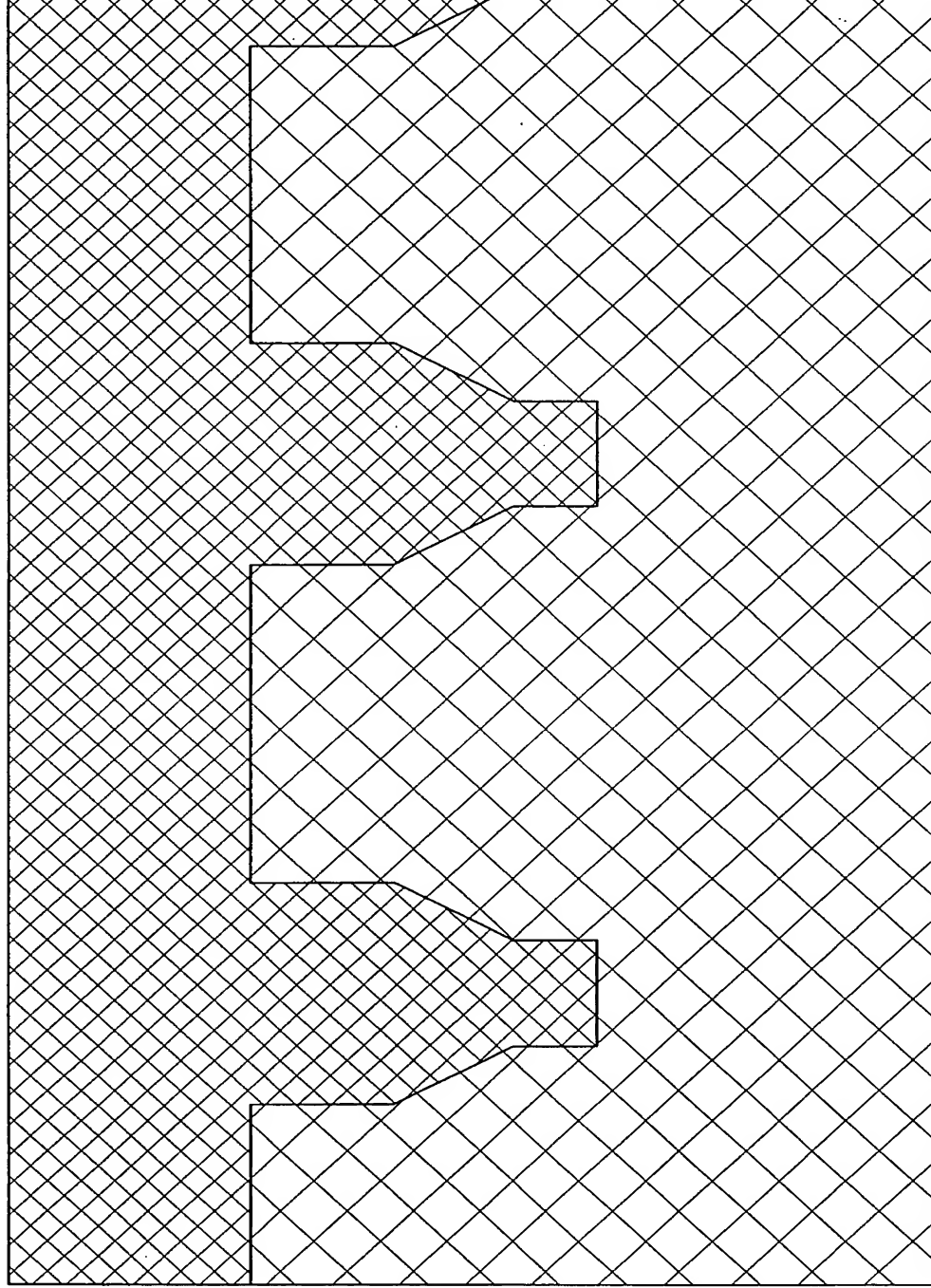


FIG. 2
(PRIOR ART)

process: Flowfill + H_2SO_4 dip + $1000^\circ C$ anneal

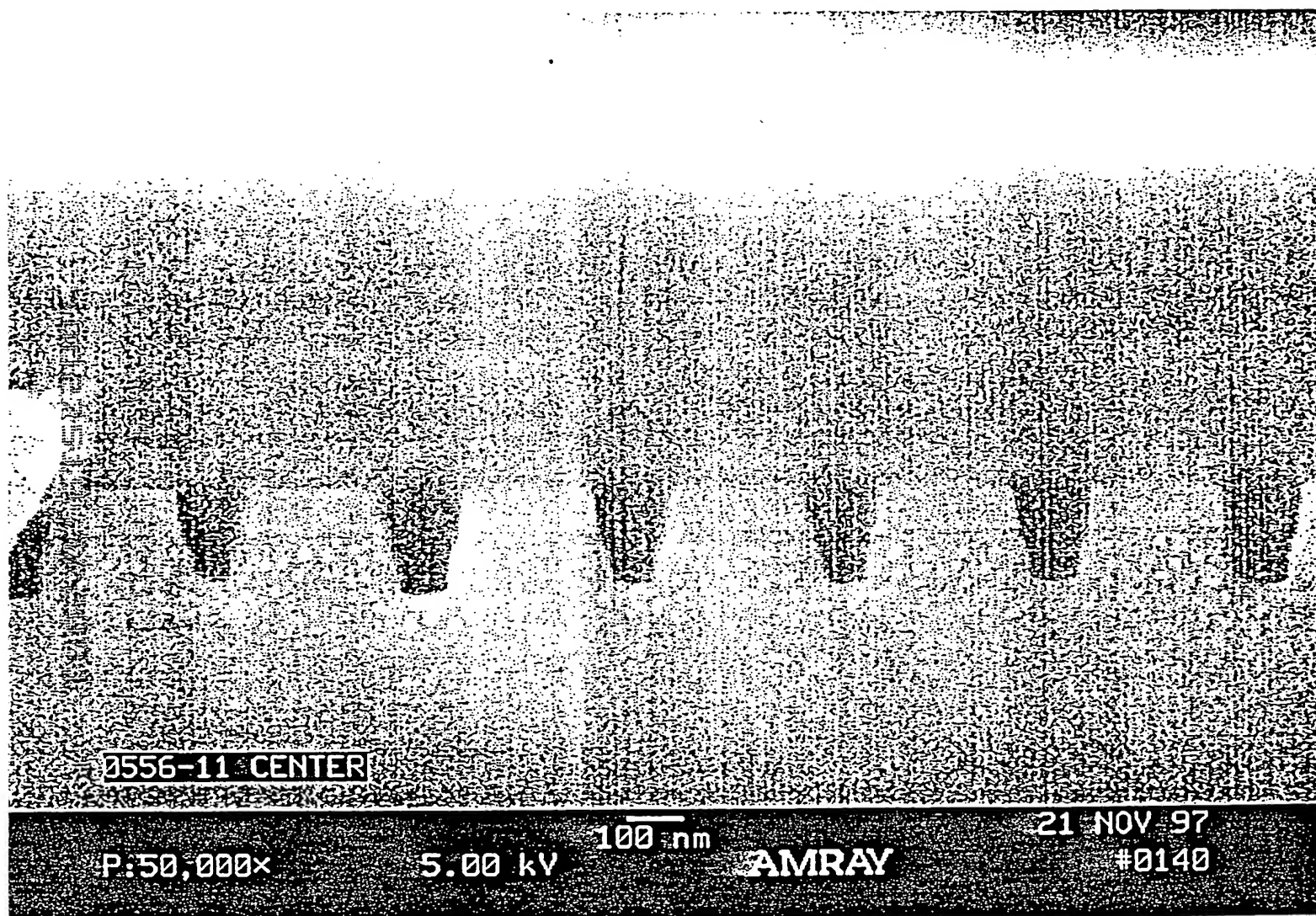


FIG. 3

process: Flowfill + H_2SO_4 dip + $1000^\circ C$ anneal

enlarged picture of wafer #11

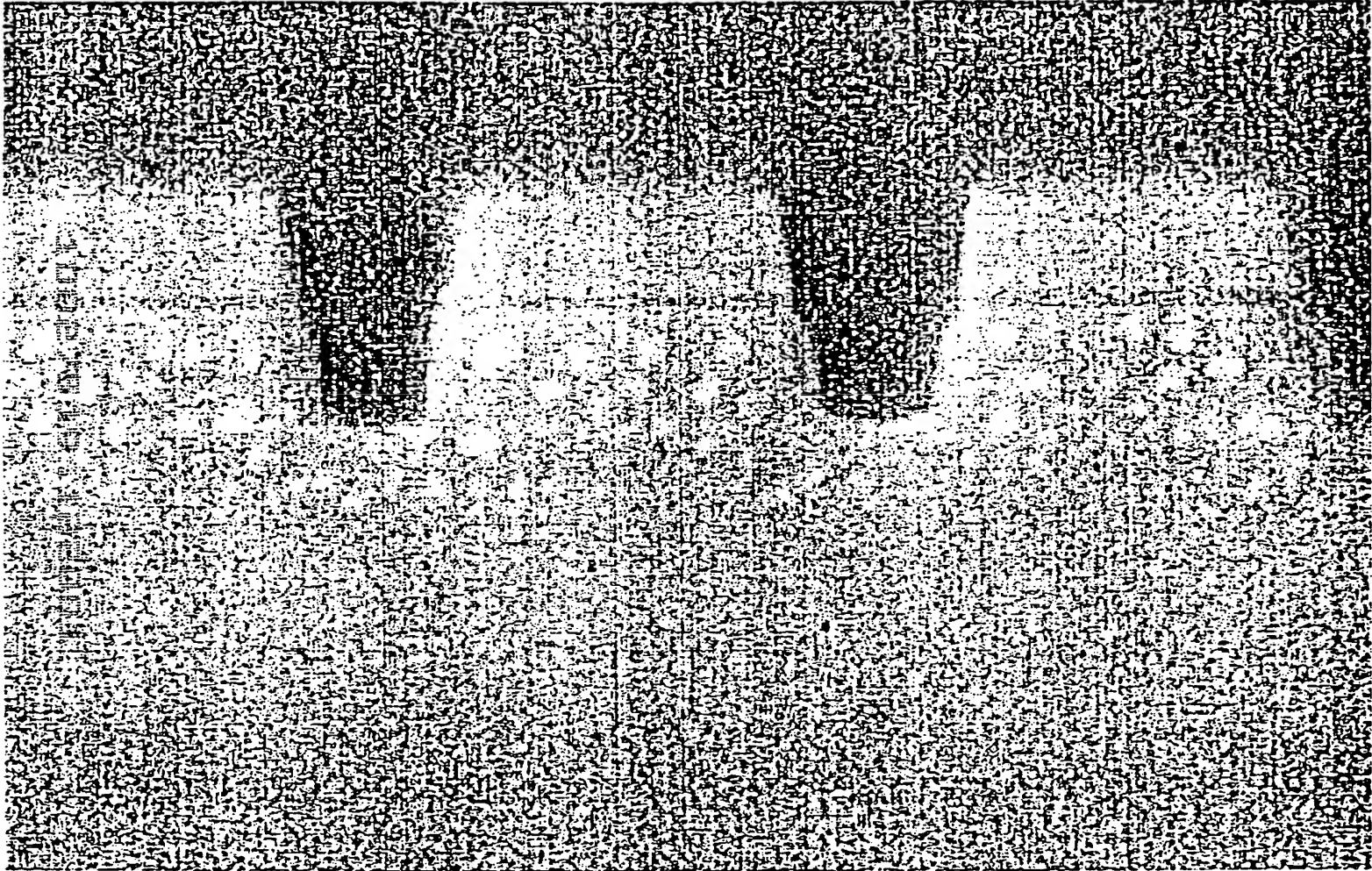


FIG. 4

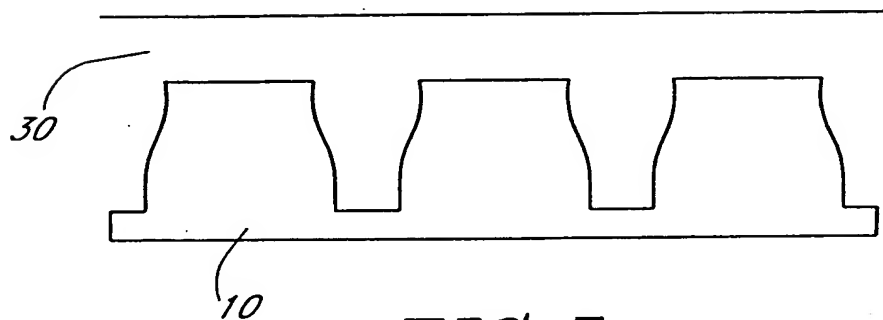


FIG. 5

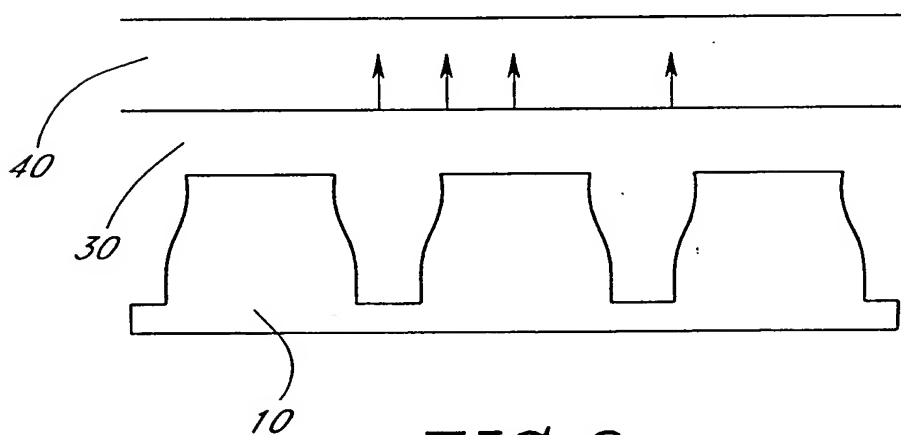


FIG. 6

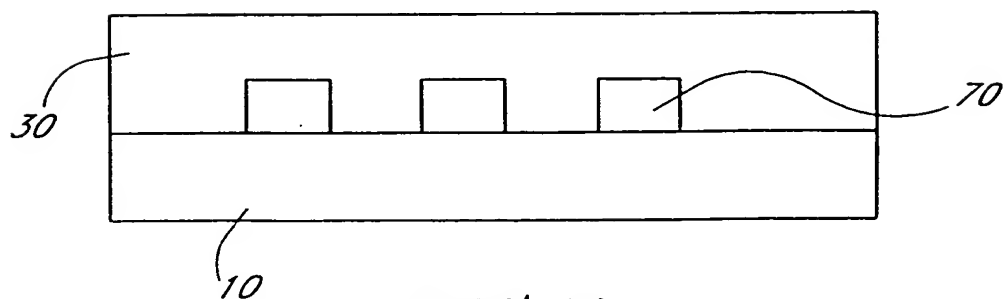


FIG. 7

10027549-122001

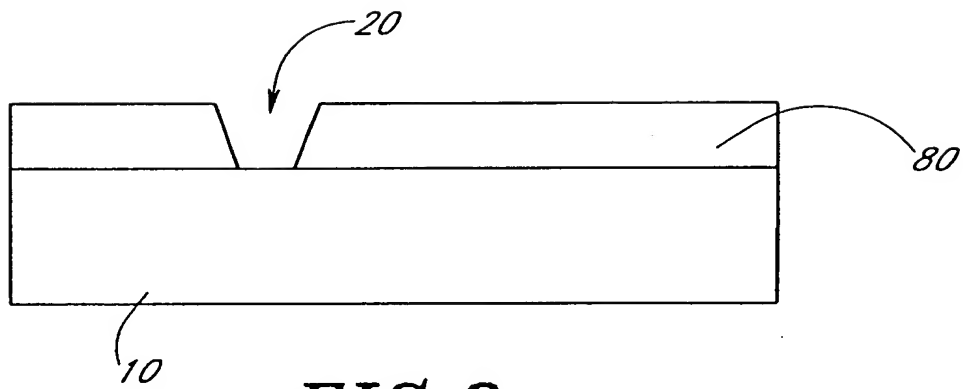


FIG. 8